### TL7759 SUPPLY-VOLTAGE SUPERVISORS

SLVS042D - JANUARY 1991 - REVISED JULY 1999

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- Precision Input Threshold
   Voltage . . . 4.55 V ±120 mV
- Low Standby Current . . . 20 μA
- Reset Outputs Defined When V<sub>CC</sub> Exceeds 1 V
- True and Complementary Reset Outputs
- Wide Supply-Voltage Range . . . 1 V to 7 V

# D, P, OR PW PACKAGE (TOP VIEW) NC 1 8 RESET NC 2 7 RESET NC 3 6 NC GND 4 5 V<sub>CC</sub>

NC - No internal connection

### description

The TL7759 is a supply-voltage supervisor designed for use as a reset controller in microcomputer and microprocessor systems. The supervisor monitors the supply voltage for undervoltage conditions. During power up, when the supply voltage,  $V_{CC}$ , attains a value approaching 1 V, the RESET and RESET outputs become active (high and low, respectively) to prevent undefined operation. If the supply voltage drops below the input threshold voltage level ( $V_{IT-}$ ), the reset outputs go to the reset active state until the supply voltage has returned to its nominal value (see timing diagram).

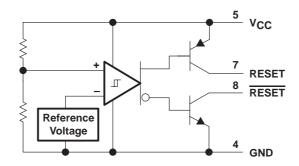
The TL7759C is characterized for operation from 0°C to 70°C

### AVAILABLE OPTIONS

		PAC	CES		
	ТА	SMALL OUTLINE (D)	PLASTIC DIP (P)	SHRINK SMALL OUTLINE (PW)	CHIP FORM (Y)
,	0°C to 70°C	TL7759CD	TL7759CP	TL7759CPW	TL7759Y

The D and PW packages are available taped and reeled. Add the suffix R to the device type (e.g., TL7759CDR). Chip forms are tested at 25°C.

### functional block diagram





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)	20 V
Off-state output voltage range: RESET voltage	
RESET voltage	0.3 V to 20 V
Low-level output current, I <sub>OL</sub> (RESET)	30 mA
High-level output current, I <sub>OH</sub> (RESET)	
Package thermal impedance, θ <sub>JA</sub> (see Notes 2 and 3): D package	
P package	127°C/W
PW package	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T <sub>stg</sub>	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to the network ground terminal.
  - 2. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.
  - The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero. 2 花 如 然

### recommended operating conditions

	36	3	MIN	MAX	UNIT
Supply voltage, V <sub>CC</sub>	Car	-01	1	7	V
Output valtage Va (acc Nate 4)		Transistor off RESET voltage		15	
Output voltage, VO (see Note 4)		Transistor off RESET voltage	0		V
Low-level output current, IOL		RESET		24	mA
High-level output current, IOH		RESET		-8	mA
Operating free-air temperature, TA		TL7759C	0	70	°C

NOTE 4: RESET output must not be pulled down below GND potential.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			7507.001	TL7759C					
			TEST CONDITIONS		MIN	TYP <sup>‡</sup>	MAX	UNIT	
VOL	Low-level output voltage	RESET	V 42V	I <sub>OL</sub> = 24 mA		0.4	0.8	V	
Vон	High-level output voltage	RESET	V <sub>CC</sub> = 4.3 V	I <sub>OH</sub> = -8 mA	V <sub>CC</sub> -1			V	
\/	Input threshold voltage (negative-going VCC)		T <sub>A</sub> = 25°C		4.43	4.55	4.67	V	
V <sub>IT</sub> –			$T_A = 0$ °C to $70$ °C	4.4		4.7			
., 8	Dawer up react veltage		D. 0.0140	T <sub>A</sub> = 25°C		0.8	1	V	
V <sub>res</sub> §	Power-up reset voltage		$R_L = 2.2 \text{ k}\Omega$	$T_A = 0$ °C to $70$ °C			1.2		
., ¶	S Hysteresis at V <sub>CC</sub> input		T <sub>A</sub> = 25°C		40	50	60	mV	
V <sub>hys</sub> ¶			$T_A = 0$ °C to 70°C		30		70	IIIV	
loH	High-level output current	RESET	V 7 V Coo Figure 4	V <sub>OH</sub> = 15 V			1	μΑ	
lOL	Low-level output current	RESET	V <sub>CC</sub> = 7 V, See Figure 1	V <sub>OL</sub> = 0 V			-1	μΑ	
la a	Cupply ourrent		Noteed	V <sub>CC</sub> = 4.3 V		1400	2000		
ICC	Supply current		No load	V <sub>CC</sub> = 5.5 V	40		40	μΑ	

 $<sup>\</sup>overline{\ddagger}$  Typical values are at T<sub>A</sub> = 25°C.

<sup>¶</sup> This is the difference between positive-going input threshold voltage, V<sub>IT+</sub>, and negative-going input threshold voltage, V<sub>IT+</sub>.



<sup>§</sup> This is the lowest voltage at which  $\overline{\text{RESET}}$  becomes active, V<sub>CC</sub> slew rate  $\leq$  5 V/ $\mu$ s.

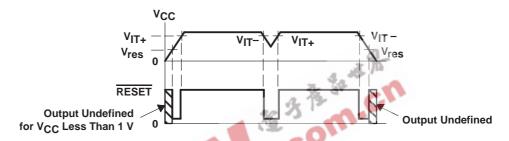
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# electrical characteristics, $T_A = 25^{\circ}C$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS		TL7759Y			
			IEST C	MIN	TYP	MAX	UNIT	
VOL	Low-level output voltage RESET		$V_{CC} = 4.3 \text{ V},$	$I_{OL} = 24 \text{ mA}$		0.4		V
V <sub>IT</sub> -	V <sub>IT</sub> — Input threshold voltage (negative-going V <sub>CC</sub> )					4.55		V
v <sub>res</sub> †	V <sub>res</sub> † Power-up reset voltage		R <sub>L</sub> = 2.2 kΩ			0.8		V
V <sub>hys</sub> ‡	Hysteresis at V <sub>CC</sub> input					50		mV
Icc	Supply current		$V_{CC} = 4.3 \text{ V},$	No load		1400		μΑ

## timing diagram



# switching characteristics at T<sub>A</sub> = 25°C (unless otherwise noted)

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	TL7759C		UNIT
	PARAMETER			TEST CONDITIONS	MIN	MAX	ONII
tPLH	Propagation delay time, low-to high-level output	VCC	RESET	See Figures 2 and 3§		5	μs
tPHL	Propagation delay time, high-to low-level output	VCC	RESET	See Figures 2 and 4		5	μs
t <sub>r</sub>	Rise time		RESET	See Figures 2 and 4§		1	μs
t <sub>f</sub>	Fall time		RESET	See Figures 2 and 4		1	μs
tw(min)	Minimum pulse duration	VCC	RESET	See Figures 2 and 4	5	·	μs

<sup>§</sup> V<sub>CC</sub> slew rate ≤ 5 V/μs

<sup>†</sup> This is the lowest voltage at which RESET becomes active, V<sub>CC</sub> slew rate ≤ 5 V/μs. ‡ This is the difference between positive-going input threshold voltage, V<sub>IT+</sub>, and negative-going input threshold voltage, V<sub>IT-</sub>.

### PARAMETER MEASUREMENT INFORMATION

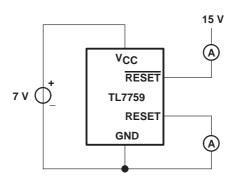
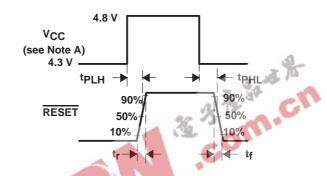
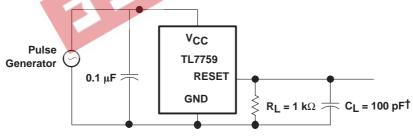


Figure 1. Test Circuit for Output Leakage Current



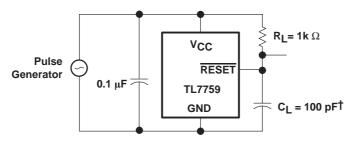
NOTE A:  $V_{CC}$  slew rate  $\leq 5 V/\mu s$ .

Figure 2. Switching Diagram



<sup>&</sup>lt;sup>†</sup>C<sub>L</sub> Includes jig and probe capacitance.

Figure 3. Test Circuit for RESET Output Switching Characteristics



<sup>&</sup>lt;sup>†</sup>C<sub>I</sub> Includes jig and probe capacitance.

Figure 4. Test Circuit for RESET Output Switching Characteristics



### **APPLICATION INFORMATION**

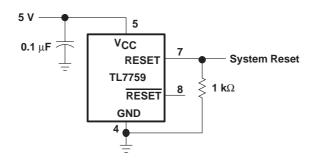


Figure 5. Power-Supply System Reset Generation



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